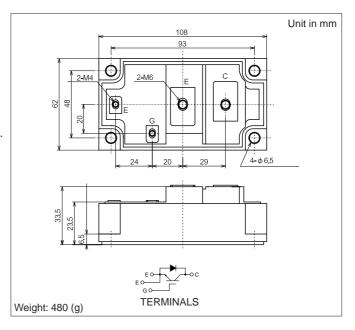
MBN400GS12BW

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High speed and low saturation voltage.
- * low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- * Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

 Item		Symbol	Unit	MBN400GS12BW		
Collector Emitter Voltage		Vces	V	1,200		
Gate Emitter Voltage		V_{GES}	V	±20		
Collector Current	DC	Ic	Α	400		
	1ms	I _{Cp}	A	800		
Forward Current	DC	lF	А	400 (1)		
	1ms	I _{FM}	A	800		
Collector Power Dissipation		Pc	W	2,000		
Junction Temperature	Tj	°C	-40 ~ +150			
Storage Temperature	T _{stg}	°C	-40 ~ +125			
Isolation Voltage	V _{ISO}	V_{RMS}	2,500(AC 1 minute)			
Screw Torque Ter	minals	-	N.m	1.37(14)/2.94(30) (2)		
Mo	unting	-	(kgf.cm)	2.94(30) (3)		

Notes:(1)RMS Current of Diode 180Arms max.

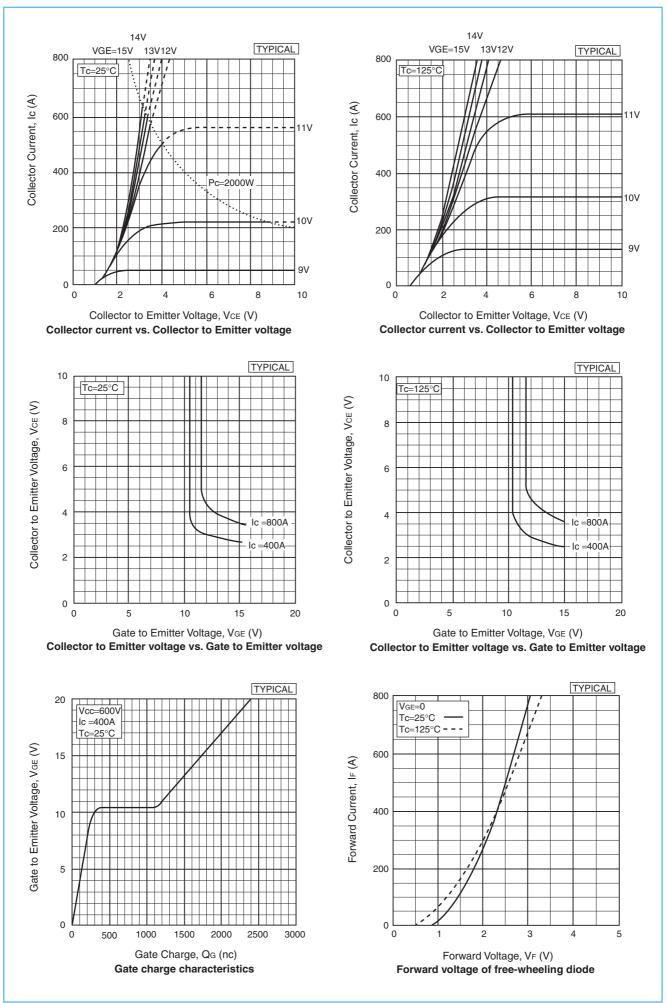
(2)Recommended Value 1.18/2.45N.m(12/25kgf.cm)

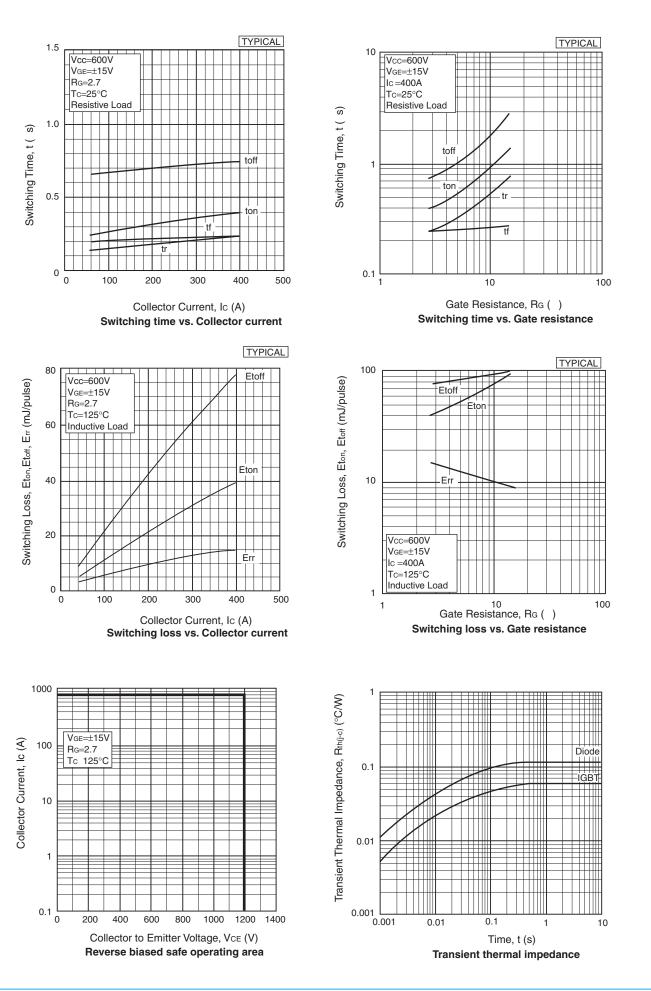
(3) Recommended Value 2.45N.m(25kgf.cm)

CHARACTERISTICS (Tc=25°C)

0.11 to 10.11 (1.0 Lo 0)								
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions	
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	1.0	V _{CE} =1,200V,V _{GE} =0V	
Gate Emitter Leakage Current		I _{GES}	nA	-	-	±500	V _{GE} =±20V,V _{CE} =0V	
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	2.7	3.4	I _C =400A,V _{GE} =15V	
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	-	-	10	$V_{CE}=5V$, $I_{C}=400mA$	
Input Capacitance		Cies	pF	-	37,000	-	V _{CE} =10V,V _{GE} =0V,f=1MHz	
	Rise Time	tr		-	0.25	0.5	V _{CC} =600V	
Switching Times	Turn On Time	ton	μS	-	0.4	0.7	$R_L=1.5\Omega$	
Ŭ	Fall Time	t _f		-	0.25	0.35	$R_G=2.7\Omega$ (4)	
	Turn Off Time	t _{off}		-	0.75	1.1	V _{GE} =±15V	
Peak Forward Voltage Drop		V _{FM}	V	-	-	3.5	I _F =400A,V _{GE} =0V	
Reverse Recovery Time		trr	μS	-	-	0.4	I _F =400A,V _{GE} =-10V, di/dt=400A/μs	
Thermal Impedance IGBT		Rth(j-c)	°C/W	-	-	0.06	Junction to case	
	FWD	Rth(j-c)		-	-	0.12		

Notes:(4) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.





HITACHI POWER SEMICONDUCTORS

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